

Printed: Mar 20, 2018

DATUM Ø0.92±0.08 ⊕ ø0.1@ X S YS ¢2.30±0.08(2X) 4.71 X А 2.71 DATUM  $\bigcirc$ 12.04±0.05 Y

213

1

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В

() Antiphenol

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AFCI

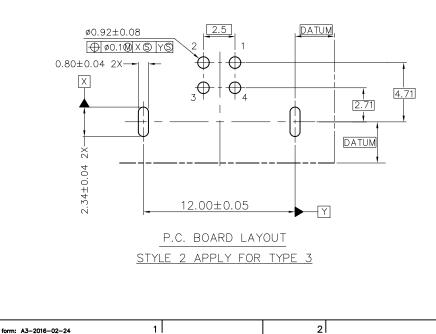
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P.C. BOARD LAYOUT STYLE 1 APPLY FOR TYPE 1 & 2



NOTES:

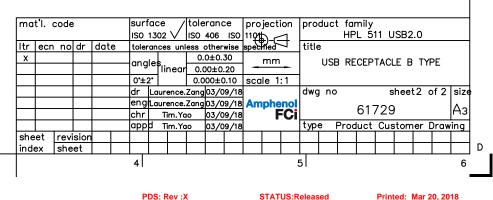
1. MATERIAL:

SHIELD & CONTACTS: COPPER ALLOY HOUSING: UL 94V-0 ,HIGHT TEMPERATURE THERMOPLASTIC. COLOR: SEE PRODUCT NUMBER CODE.

- 2. PLATING: SEE PRODUCT NUMBER CODE.
  - SHIELD: BRIGHT TIN. NICKEL UNDERPLATE(USED FOR WAVE SOLDER PROCESS). PLATING NICKEL ONLY(USED FOR PIP PROCESS).

51

- 3. DATUMS & BASIC DIMENSIONS TO BE DETERMINED BY CUSTOMER
- 4. RECOMMENDED BOARD THICKNESS IS 1.57 mm (.062)
- 5 PACKING STANDARD GS-14-920 WILL BE APPLIED FOR LEAD FREE P/N'S
- 6. FOR LEAD FREE P/N, THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008
- 7. FOR LEAD FREE P/N'S. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TERMERATURE FOR 10 SECONDS IN A CONVECTION. INFRO-RED OR VAPOR PHASE REFLOW OVEN.
- 8. THE PART CAN BE USED FOR PIP PROCESS.



PDS: Rev :X

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## **Mouser Electronics**

Authorized Distributor

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FCI / Amphenol: 61729-01Q0RLF